



11A, 700V SUPER JUNCTION MOS POWER TRANSISTOR

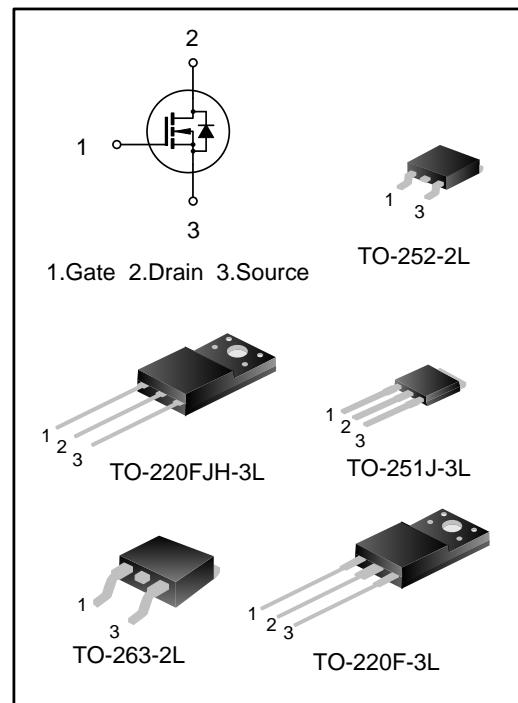
DESCRIPTION

SVS11N70FJH/D/MJ/S/FD2 is an N-channel enhancement mode high voltage power MOSFETs produced using Silan's super junction MOS technology. It achieves low conduction loss and switching losses. It leads the design engineers to their power converters with high efficiency, high power density, and superior thermal behavior.

Furthermore, it's universal applicable, for example, it is suitable for hard and soft switching topologies.

FEATURES

- 11A,700V, $R_{DS(on)(typ.)}=0.37\Omega @ V_{GS}=10V$
- New revolutionary high voltage technology
- Ultra low gate charge
- Enhanced avalanche capability
- Extreme dv/dt rated
- High peak current capability



ORDERING INFORMATION

Part No.	Package	Marking	Hazardous substance control	Packing Type
SVS11N70FJHD2	TO-220FJH-3L	11N70FJH	Halogen free	Tube
SVS11N70DD2TR	TO-252-2L	11N70DD2	Halogen free	Tape & Reel
SVS11N70MJD2	TO-251J-3L	11N70MJD2	Halogen free	Tube
SVS11N70SD2	TO-263-2L	11N70SD2	Halogen free	Tube
SVS11N70FD2	TO-220F-3L	11N70FD2	Halogen free	Tube



ABSOLUTE MAXIMUM RATINGS (UNLESS OTHERWISE NOTED, TA=25°C)

Characteristics	Symbol	Ratings			Unit	
		SVS11N70 FD2/FJHD2	SVS11N70 DD2/MJD2	SVS11N70 SD2		
Drain-Source Voltage	V _{DS}	700		V		
Gate-Source Voltage	V _{GS}	±30		V		
Drain Current	T _C =25°C	I _D	11		A	
	T _C =100°C		7			
Drain Current Pulsed	I _{DM}	44		A		
Power Dissipation (T _C =25°C) - Derate above 25°C	P _D	37	130	139	W	
		0.3	1.0	1.1	W/°C	
Single Pulsed Avalanche Energy (Note 1)	E _{AS}	576		mJ		
Reverse diode dv/dt (Note 2)	dv/dt	15		V/ns		
MOSFET dv/dt ruggedness (Note 3)	dv/dt	50		V/ns		
Operation Junction Temperature Range	T _J	-55~+150		°C		
Storage Temperature Range	T _{stg}	-55~+150		°C		

THERMAL CHARACTERISTICS

Characteristics	Symbol	Ratings			Unit
		SVS11N70 FD2/FJHD2	SVS11N70 DD2/MJD2	SVS11N70 SD2	
Thermal Resistance, Junction-to-Case	R _{θJC}	3.4	0.96	0.9	°C/W
Thermal Resistance, Junction-to-Ambient	R _{θJA}	62.5	62.5	62.5	°C/W



ELECTRICAL CHARACTERISTICS (UNLESS OTHERWISE NOTED, $T_J=25^\circ\text{C}$)

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Drain -Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	700	--	--	V
Drain-Source Leakage Current	$I_{\text{DS}(\text{off})}$	$V_{\text{DS}}=700\text{V}, V_{\text{GS}}=0\text{V}$	--	--	1.0	μA
Gate-Source Leakage Current	I_{GSS}	$V_{\text{GS}}=\pm 30\text{V}, V_{\text{DS}}=0\text{V}$	--	--	± 100	nA
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{GS}}=V_{\text{DS}}, I_{\text{D}}=250\mu\text{A}$	2.0	--	4.0	V
Static Drain- Source on State Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=5.5\text{A}$	--	0.37	0.42	Ω
Gate resistance	R_g	$f=1.0\text{MHz}$	--	4.7	--	Ω
Input Capacitance	C_{iss}	$f=1\text{MHz}, V_{\text{GS}}=0\text{V}, V_{\text{DS}}=100\text{V}$	--	673	--	pF
Output Capacitance	C_{oss}		--	37	--	
Reverse Transfer Capacitance	C_{rss}		--	2.3	--	
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}}=350\text{V}, V_{\text{GS}}=10\text{V}, R_g=24\Omega, I_{\text{D}}=11\text{A}$ (Note 4,5)	--	14	--	ns
Turn-on Rise Time	t_r		--	37	--	
Turn-off Delay Time	$t_{\text{d}(\text{off})}$		--	70	--	
Turn-off Fall Time	t_f		--	33	--	
Total Gate Charge	Q_g	$V_{\text{DD}}=560\text{V}, V_{\text{GS}}=10\text{V}, I_{\text{D}}=11\text{A}$ (Note 4,5)	--	24	--	nC
Gate-Source Charge	Q_{gs}		--	5.2	--	
Gate-Drain Charge	Q_{gd}		--	12	--	

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Continuous Source Current	I_s	Integral Reverse P-N Junction Diode in the MOSFET	--	--	11	A
Pulsed Source Current	I_{SM}		--	--	44	
Diode Forward Voltage	V_{SD}	$I_s=11\text{A}, V_{\text{GS}}=0\text{V}$	--	--	1.4	V
Reverse Recovery Time	T_{rr}	$I_s=11\text{A}, V_{\text{GS}}=0\text{V},$ $dI_f/dt=100\text{A}/\mu\text{s}$ (Note 4)	--	374	--	ns
Reverse Recovery Charge	Q_{rr}		--	3.9	--	μC

Notes:

1. $L=79\text{mH}, I_{\text{AS}}=3.5\text{A}, V_{\text{DD}}=100\text{V}, R_g=25\Omega$, starting $T_J=25^\circ\text{C}$;
2. $V_{\text{DS}}=0\sim 400\text{V}, I_{\text{SD}} \leq 11\text{A}, T_J=25^\circ\text{C}$;
3. $V_{\text{DS}}=0\sim 480\text{V}$;
4. Pulse Test: Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$;
5. Essentially independent of operating temperature.



TYPICAL CHARACTERISTICS

Figure 1. On-Region Characteristics

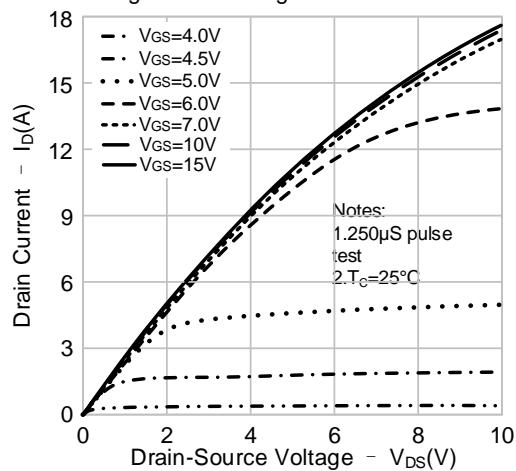


Figure 2. Transfer Characteristics

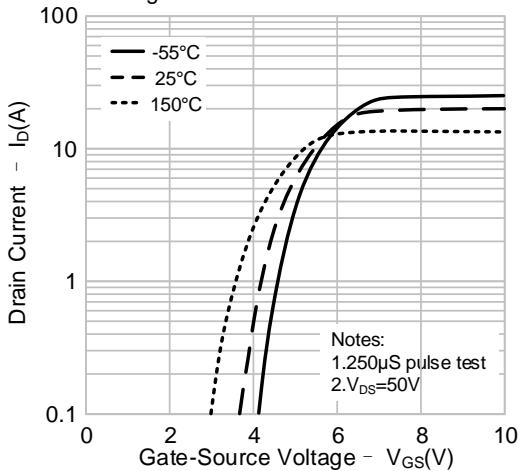


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

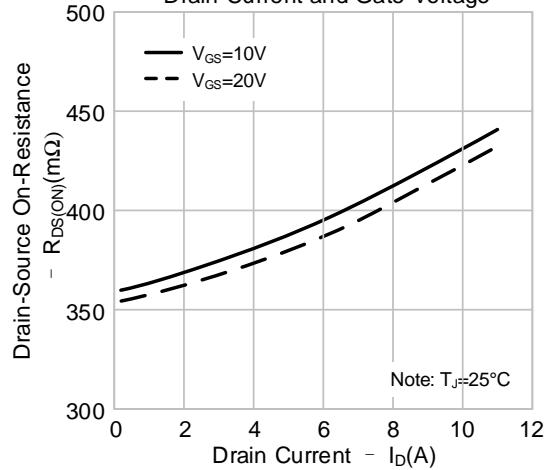


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

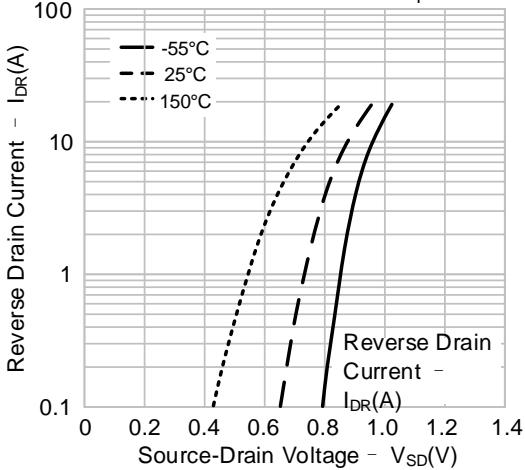


Figure 5. Capacitance Characteristics

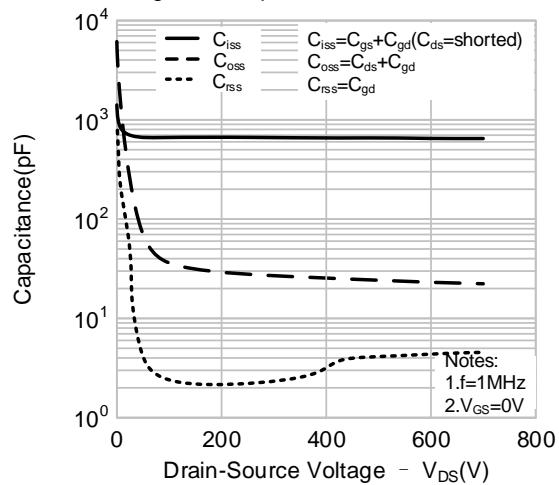
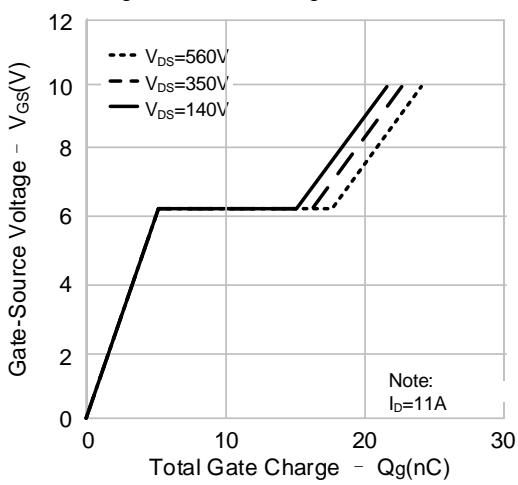
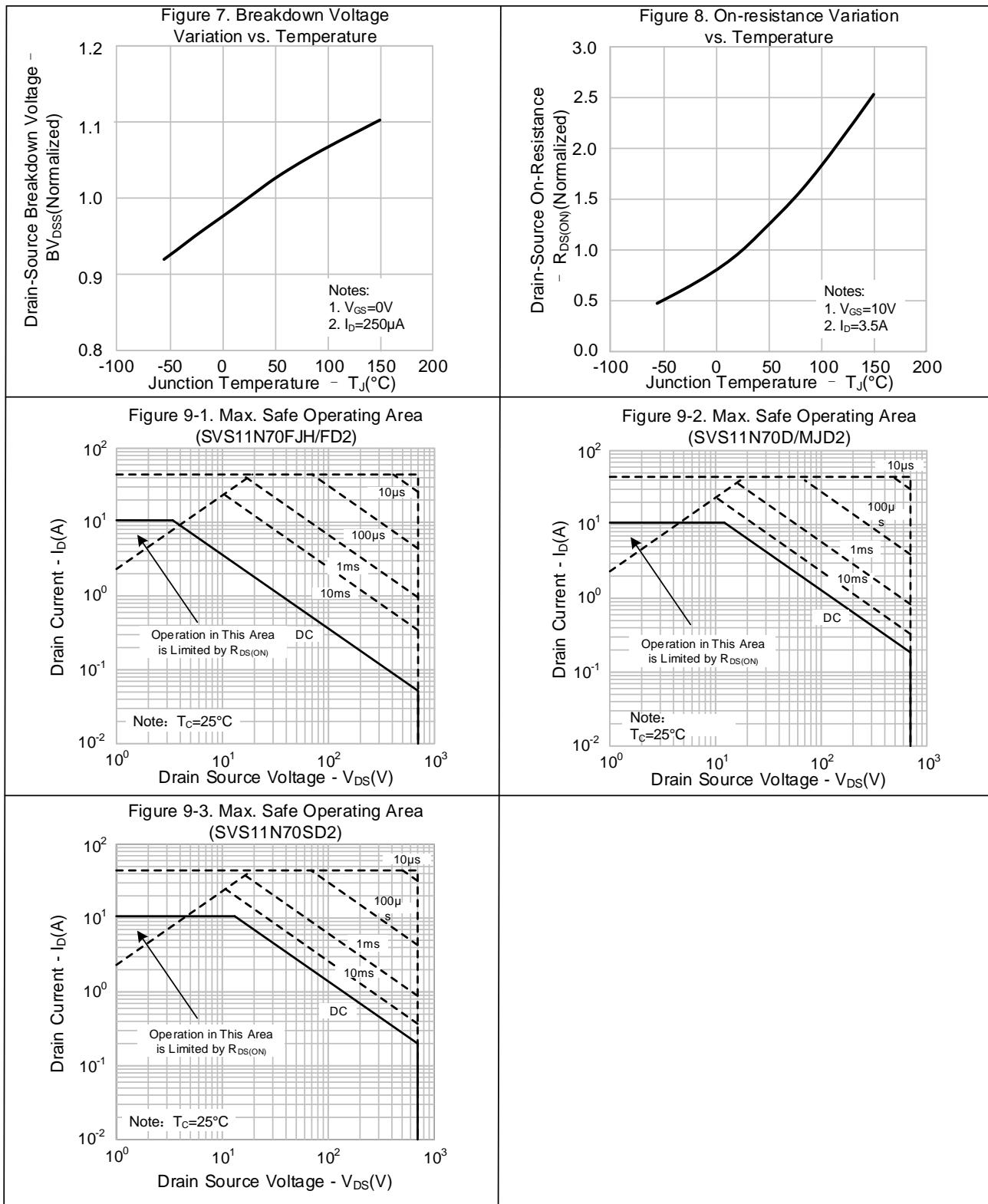


Figure 6. Gate Charge Characteristics





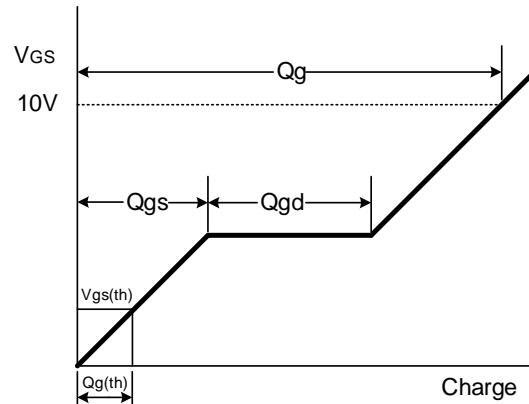
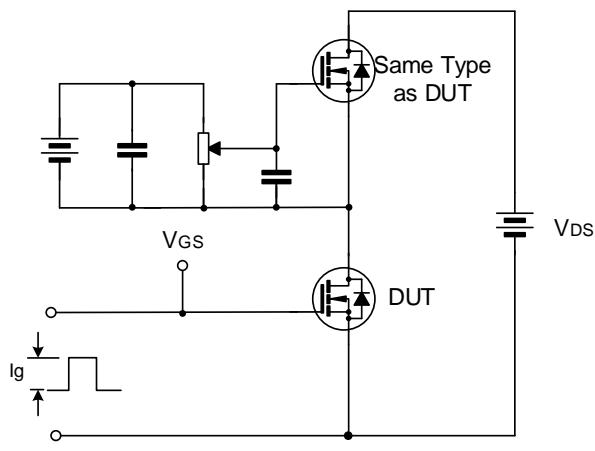
TYPICAL CHARACTERISTICS (CONTINUED)



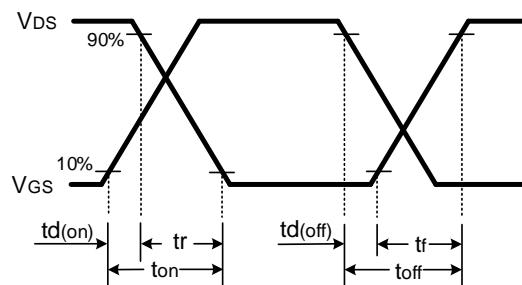
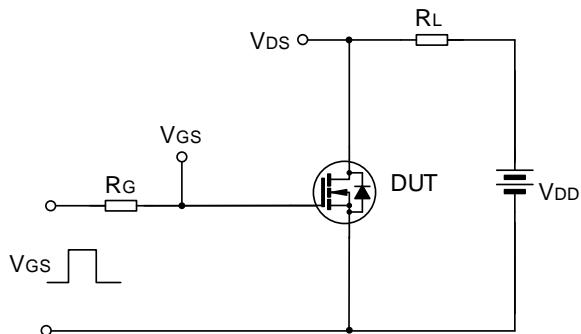


TYPICAL TEST CIRCUIT

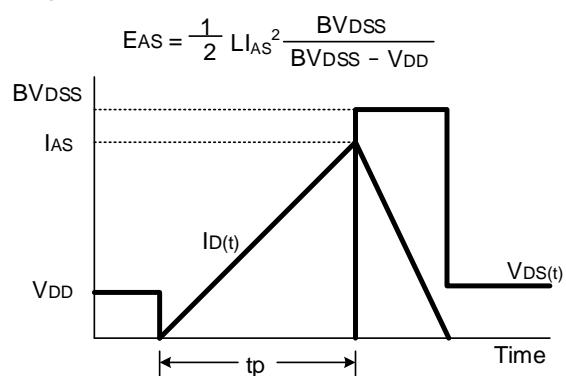
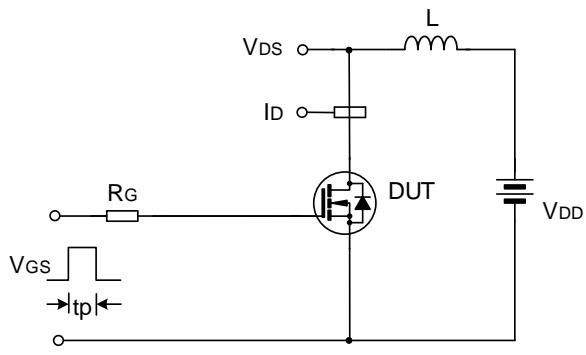
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveform



Unclamped Inductive Switching Test Circuit & Waveform

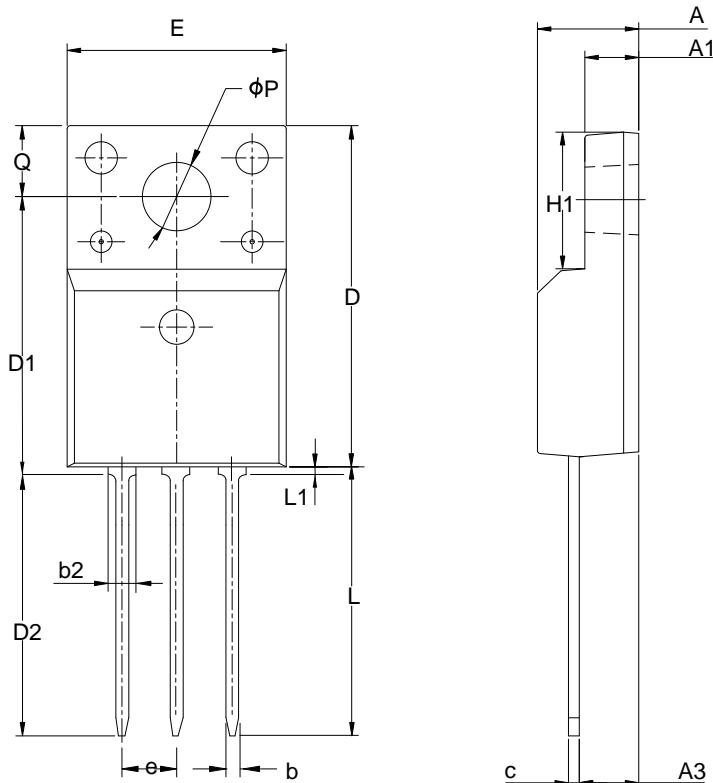




PACKAGE OUTLINE

TO-220FJH-3L

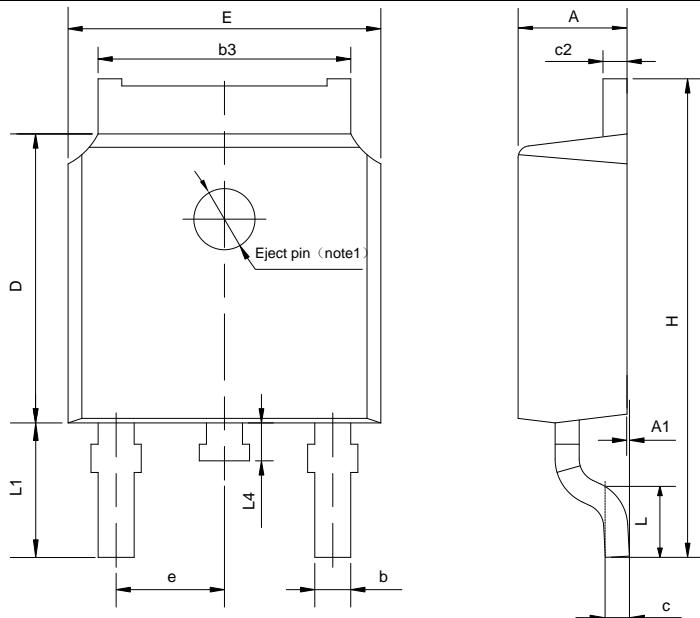
Unit: mm



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	4.42	4.70	5.02
A1	2.30	2.54	2.80
A3	2.50	2.76	3.10
b	0.55	0.70	0.80
b2	—	—	1.29
c	0.35	0.50	0.65
D	15.25	15.87	16.25
D1	12.87	13.07	13.27
D2	12.28	12.48	12.68
E	9.73	10.16	10.36
e	2.54BCS		
H1	6.40	6.68	7.00
L	12.48	12.98	13.48
L1	—	—	0.85
φP	3.00	3.18	3.40
Q	3.05	3.30	3.55

TO-252-2L

Unit: mm



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	2.10	2.30	2.50
A1	0	—	0.127
b	0.66	0.76	0.89
b3	5.10	5.33	5.46
c	0.45	—	0.65
c2	0.45	—	0.65
D	5.80	6.10	6.40
E	6.30	6.60	6.90
e	2.30TYP		
H	9.60	10.10	10.60
L	1.40	1.50	1.70
L1	2.90REF		
L4	0.60	0.80	1.00

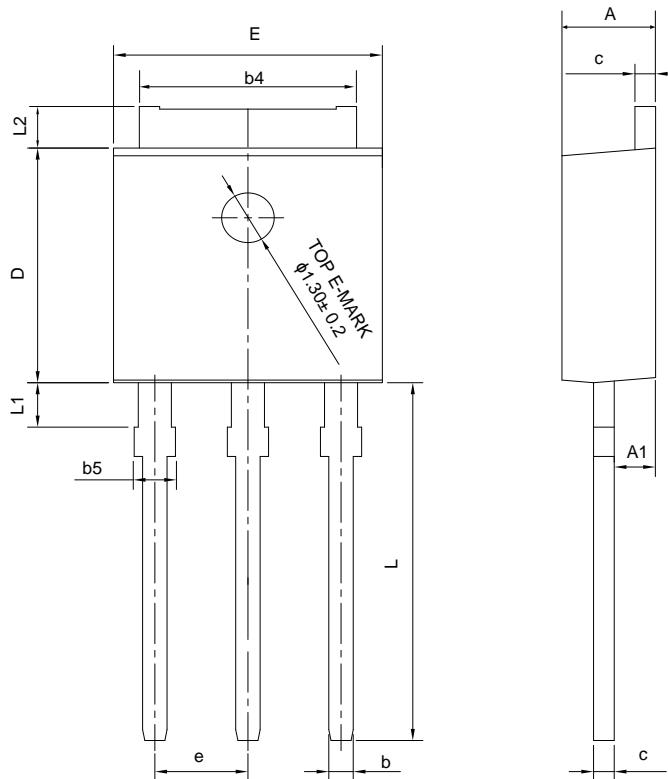
NOTE1 : There are two conditions for this position:has an eject pin or has no eject pin.



PACKAGE OUTLINE(CONTINUED)

TO-251J-3L

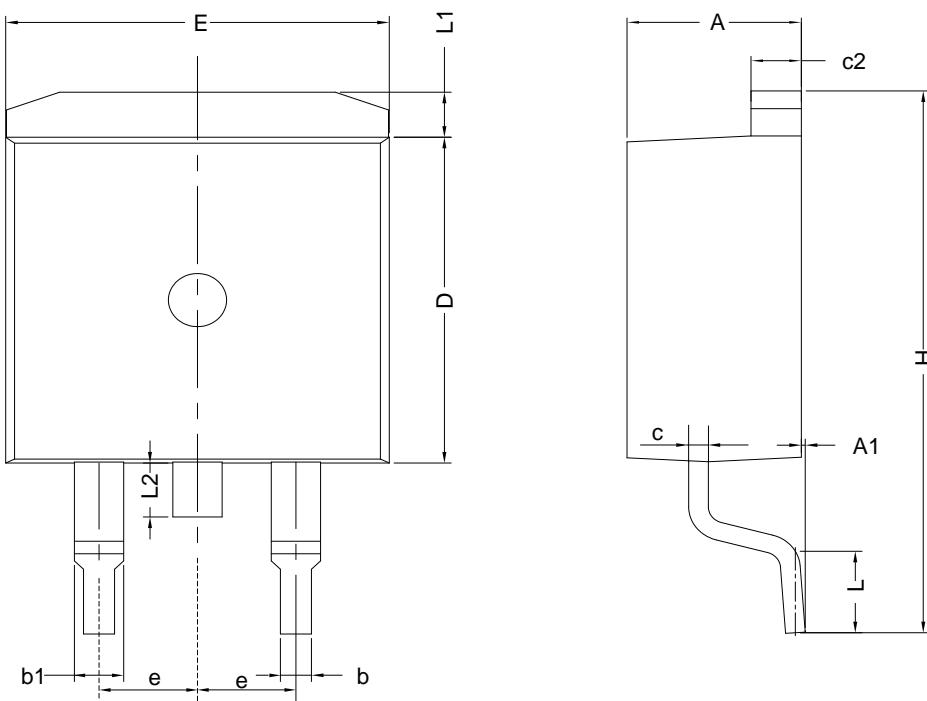
Unit: mm



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	2.18	2.30	2.39
A1	0.89	1.00	1.14
b	0.56	—	0.89
b4	4.95	5.33	5.46
b5	—	—	1.05
c	0.46	—	0.61
D	5.97	6.10	6.27
E	6.35	6.60	6.73
e	2.29 BCS		
L	8.89	9.30	9.65
L1	0.95	—	1.50
L2	0.89	—	1.27

TO-263-2L

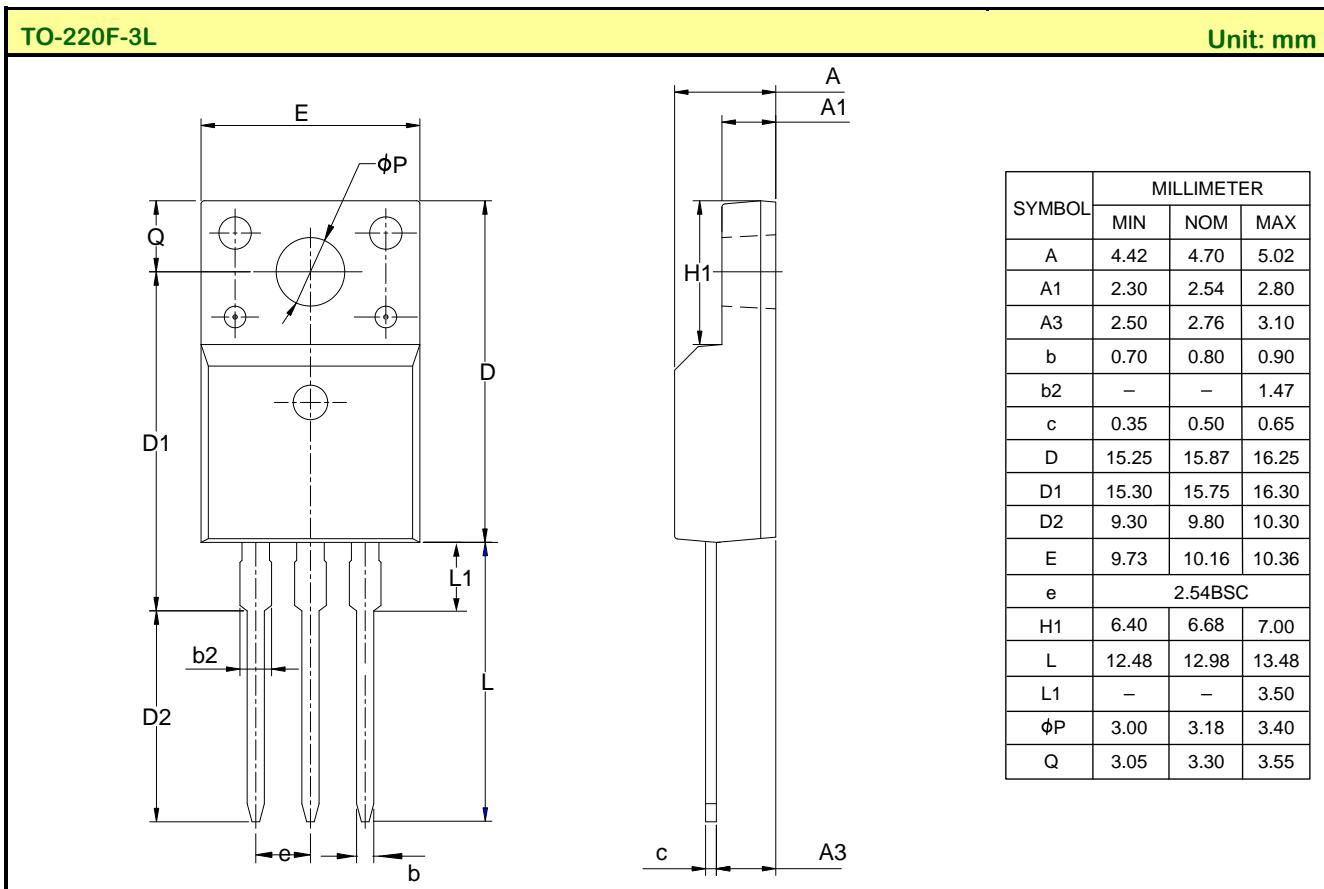
Unit: mm



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	4.30	4.57	4.72
A1	0	0.10	0.25
b	0.71	0.81	0.91
c	0.30	—	0.60
c2	1.17	1.27	1.37
D	8.50	—	9.35
E	9.80	—	10.45
e	2.54BSC		
H	14.70	—	15.75
L	2.00	2.30	2.74
L1	1.12	1.27	1.42
L2	—	—	1.75



PACKAGE OUTLINE(CONTINUED)



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- The instructions are subject to change without notice! Customers should obtain the latest relevant information before placing orders and should verify that such information is complete and current.
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- Product promotion is endless, our company will wholeheartedly provide customers with better products!
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SVS11N70FJH/D/MJ/S/FD2_Datasheet

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Document Type: Datasheet

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Rev.: 1.2

Revision History:

1. Modify Electrical schematic and TYPICAL TEST CIRCUIT
 2. Deleted NOMENCLATURE
 3. Changed the template
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Rev.: 1.1

Revision History:

1. Add SVS11N70DD2、SVS11N70MJD2、SVS11N70SD2、SVS11N70FD2
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Rev.: 1.0

Revision History:

1. First release
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